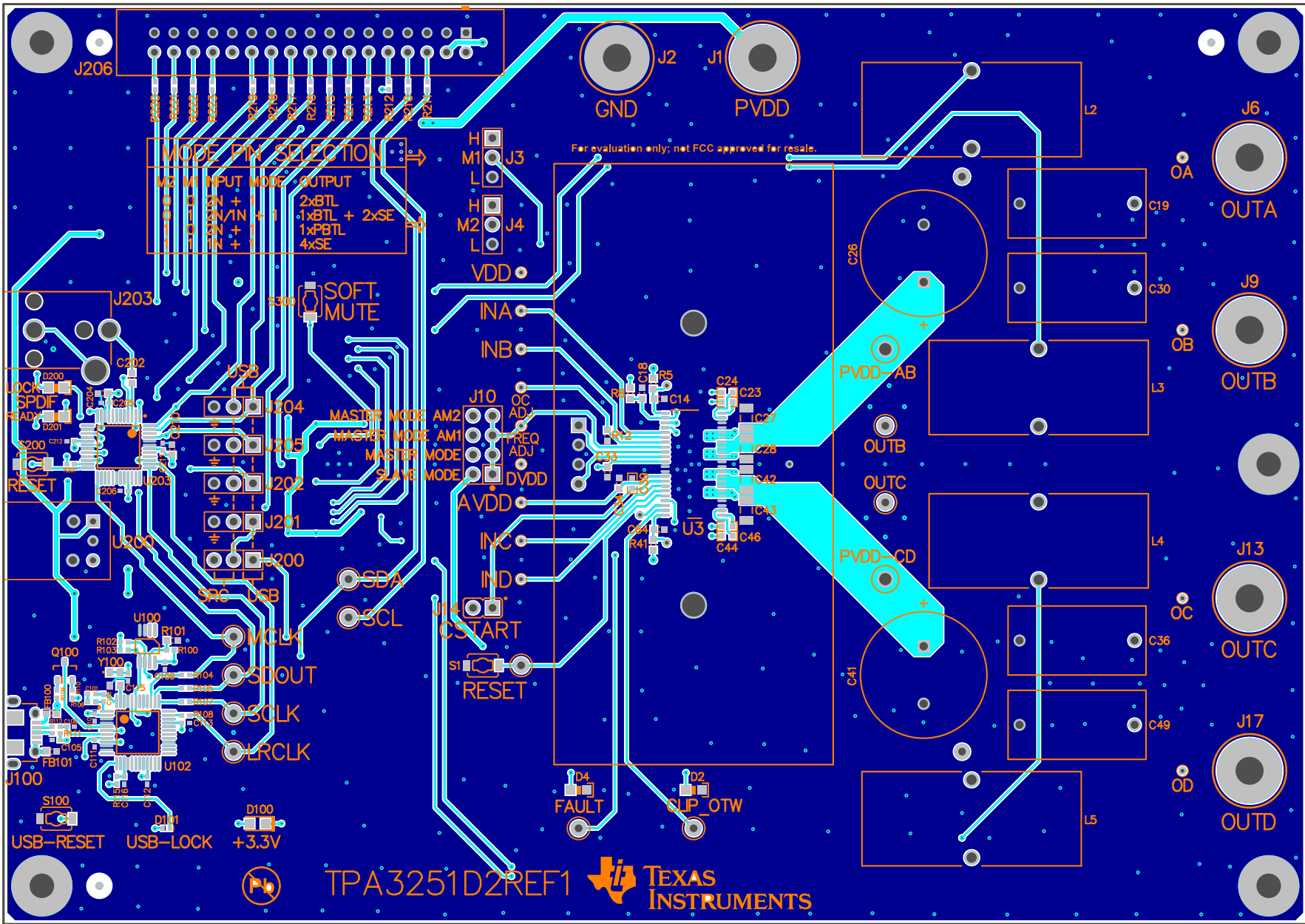
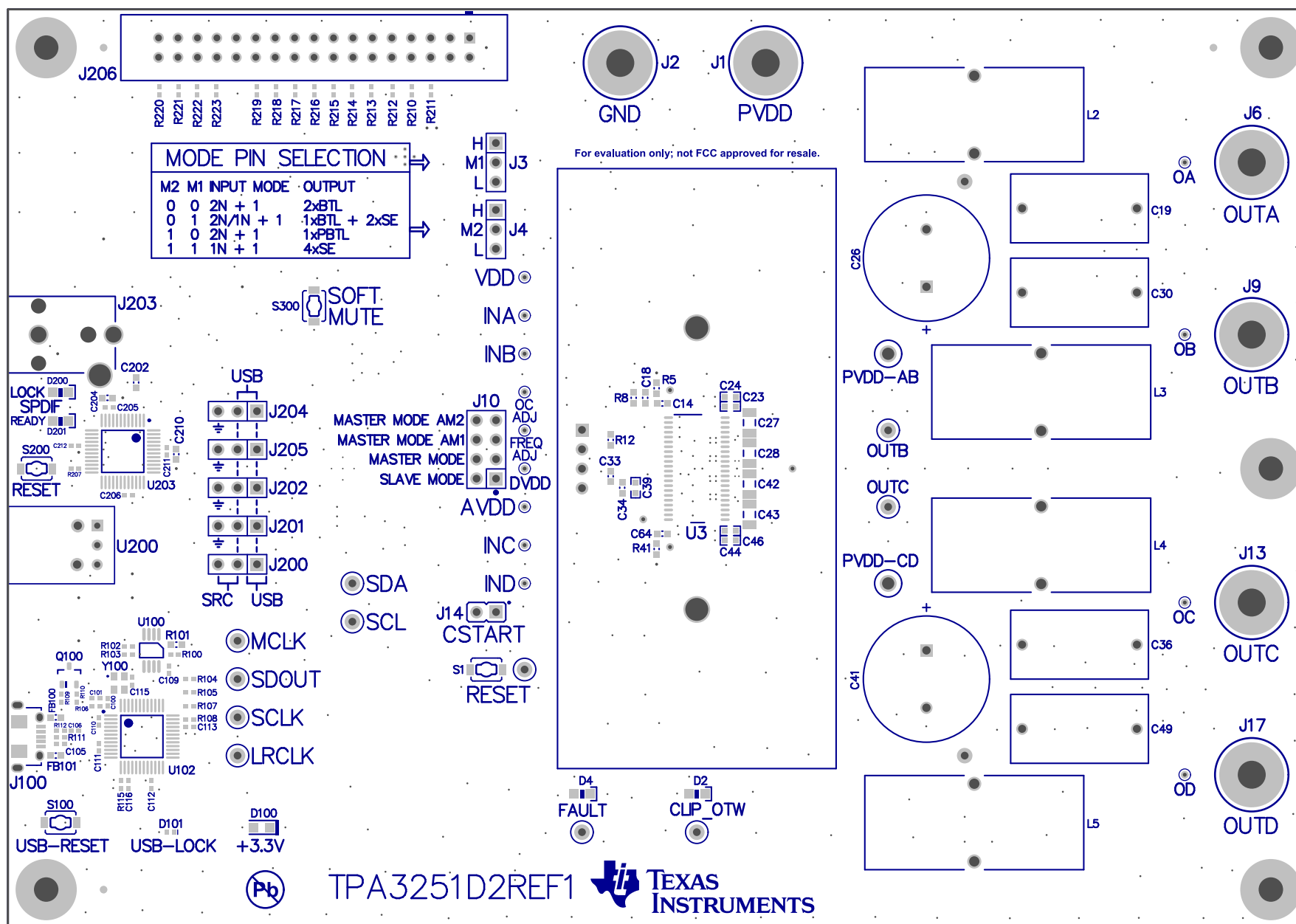
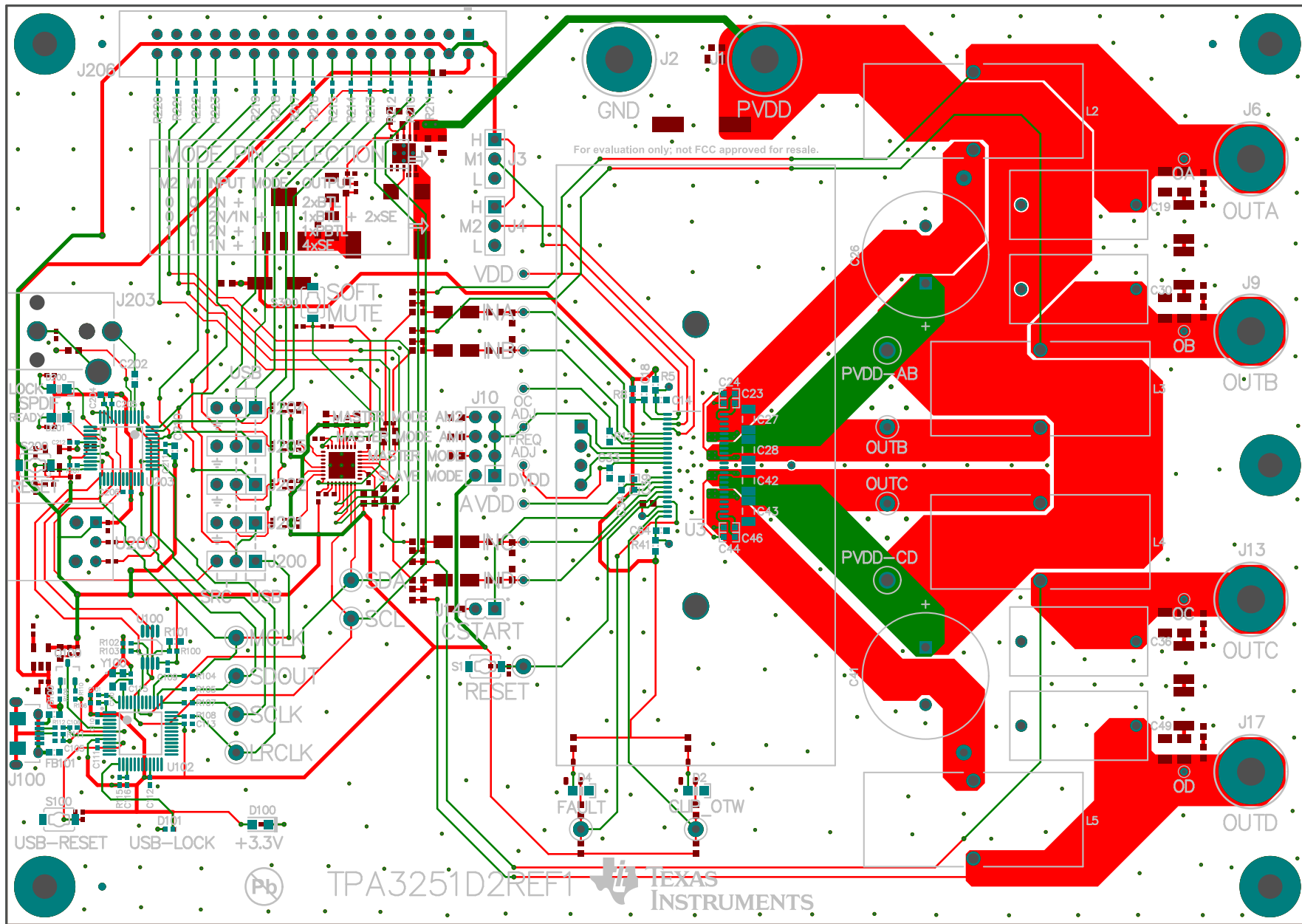


Top Silkscreen
Top Copper
Top Copper

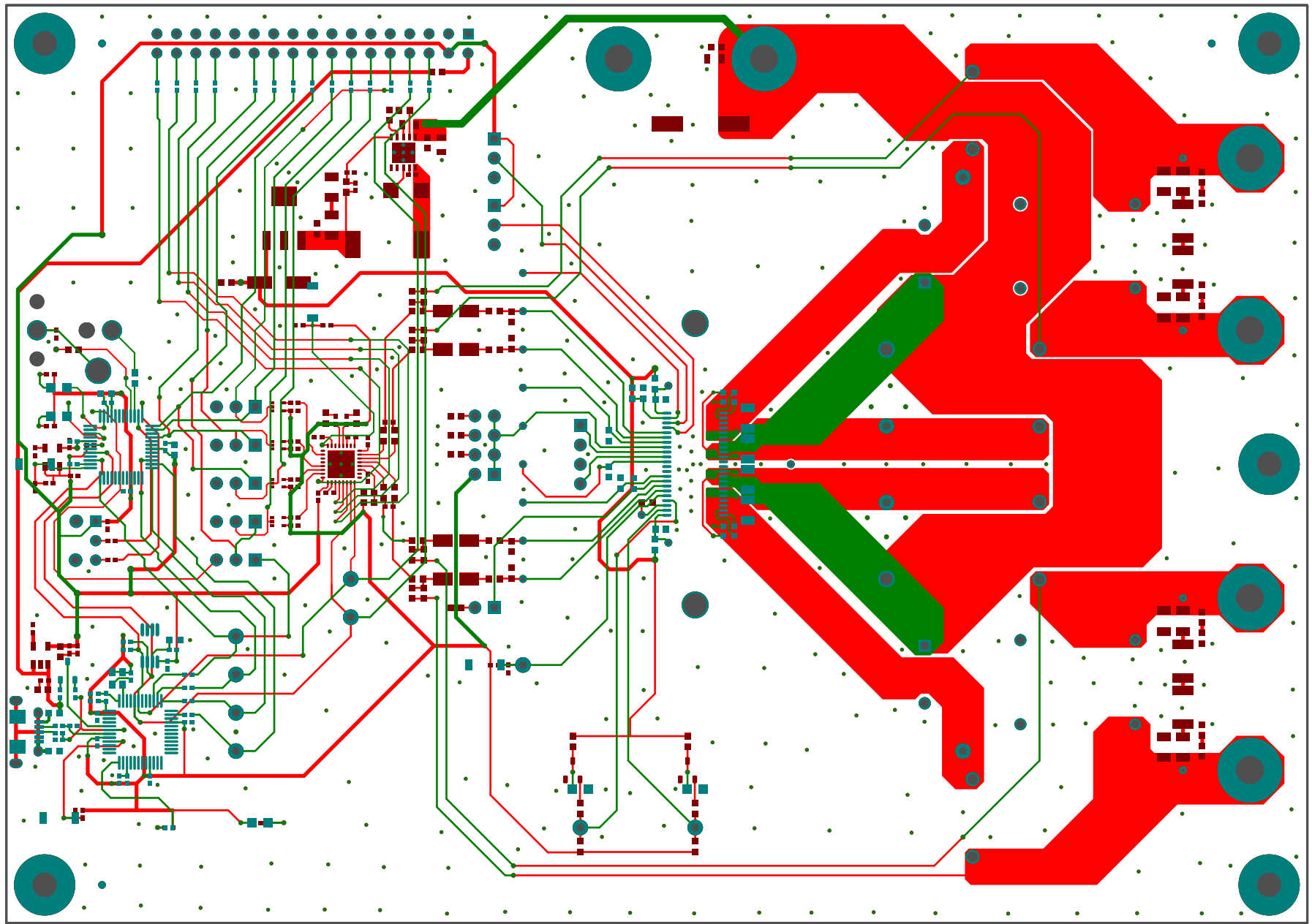


TPA3251D2REF1  TEXAS INSTRUMENTS



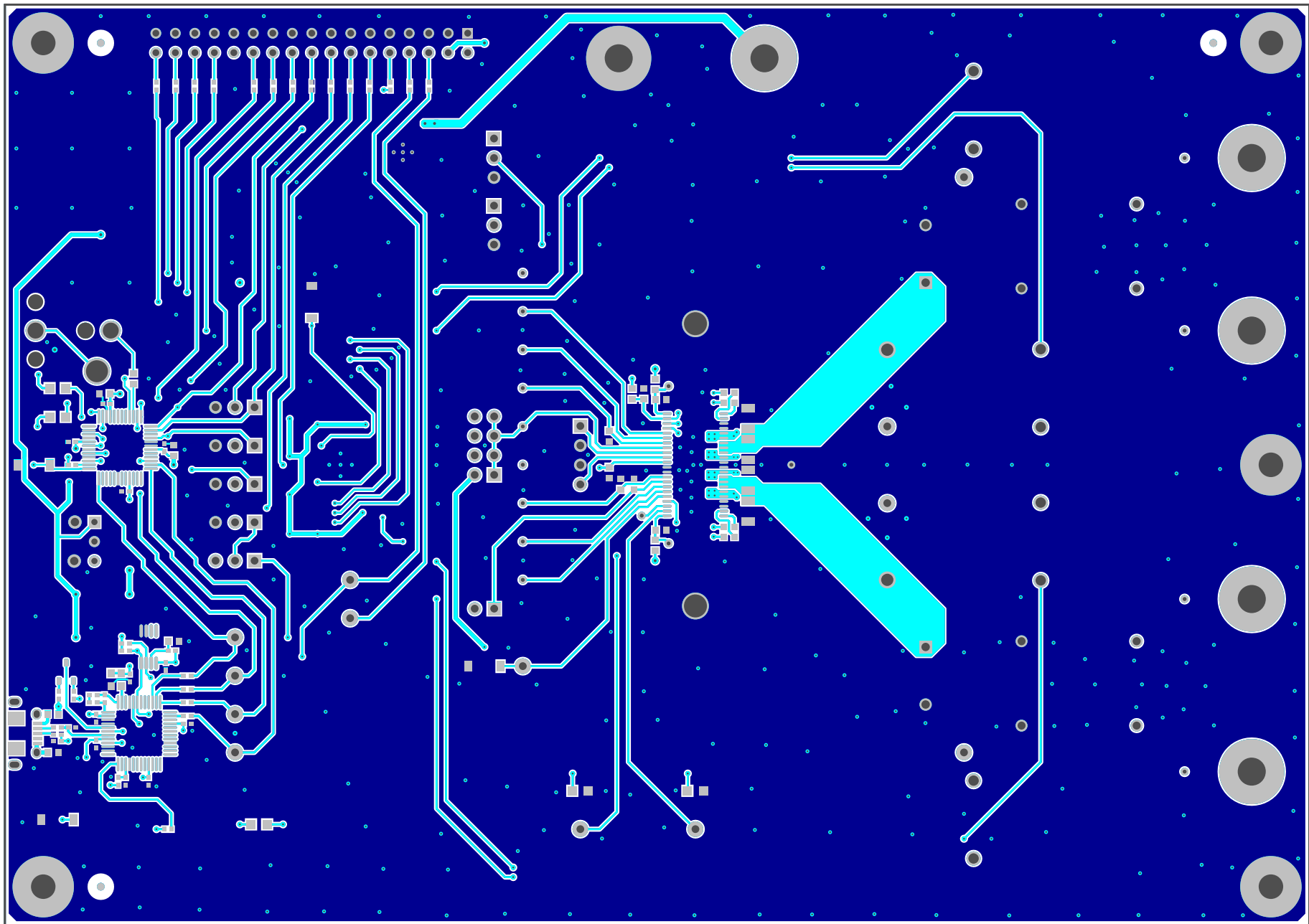


Top Silkscreen
 Top Copper
 Bottom Copper

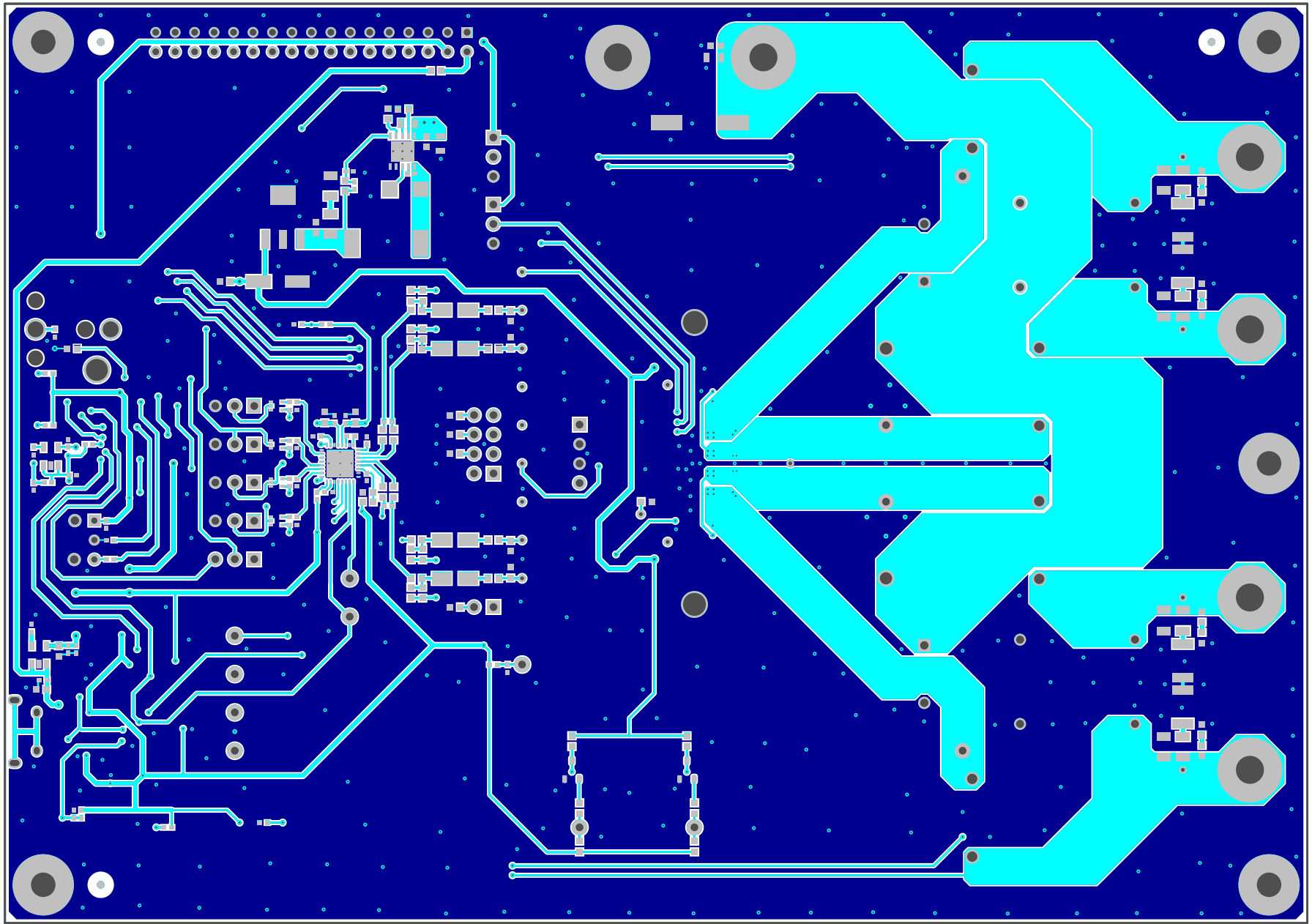


Top Copper

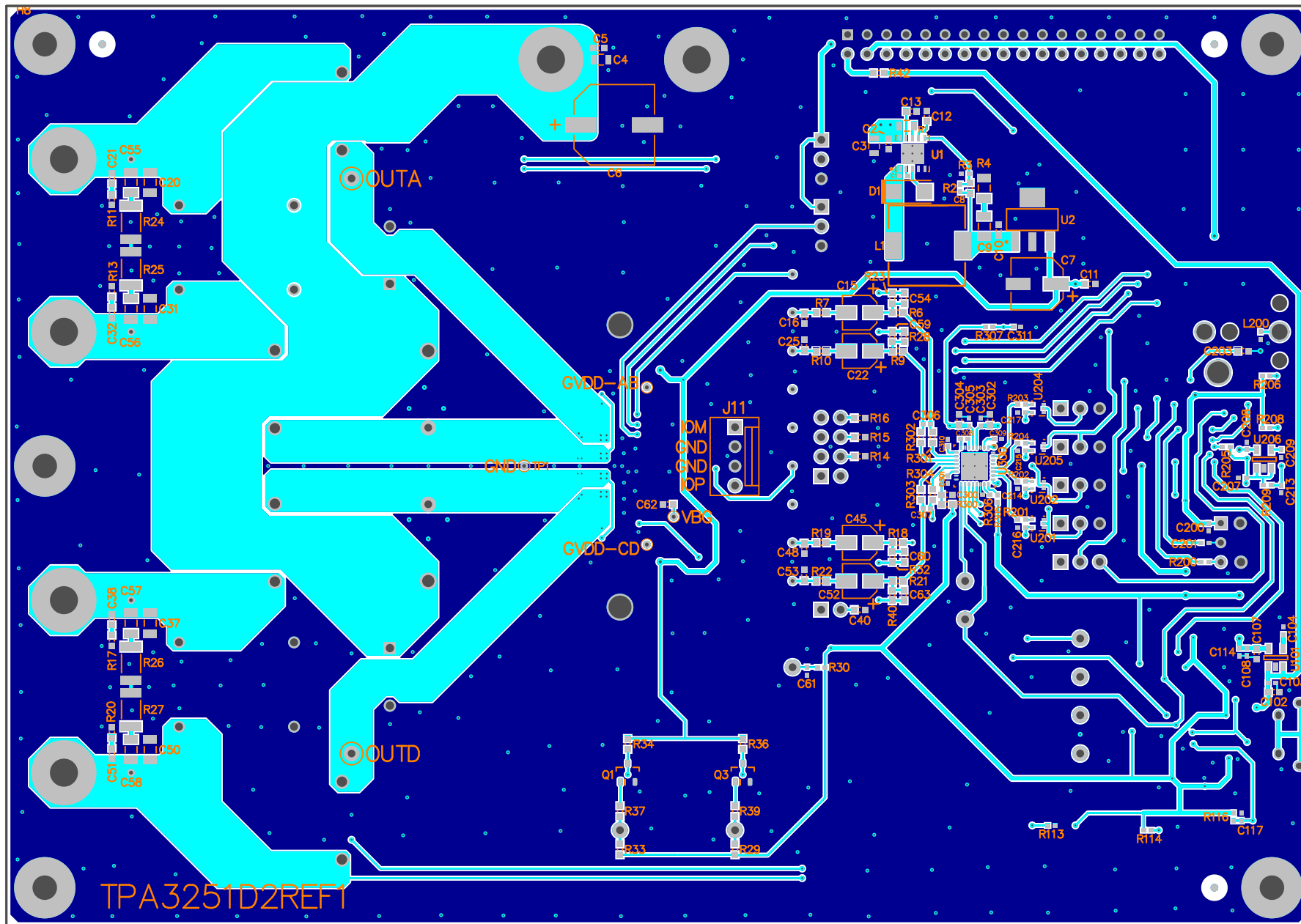
Bottom Copper



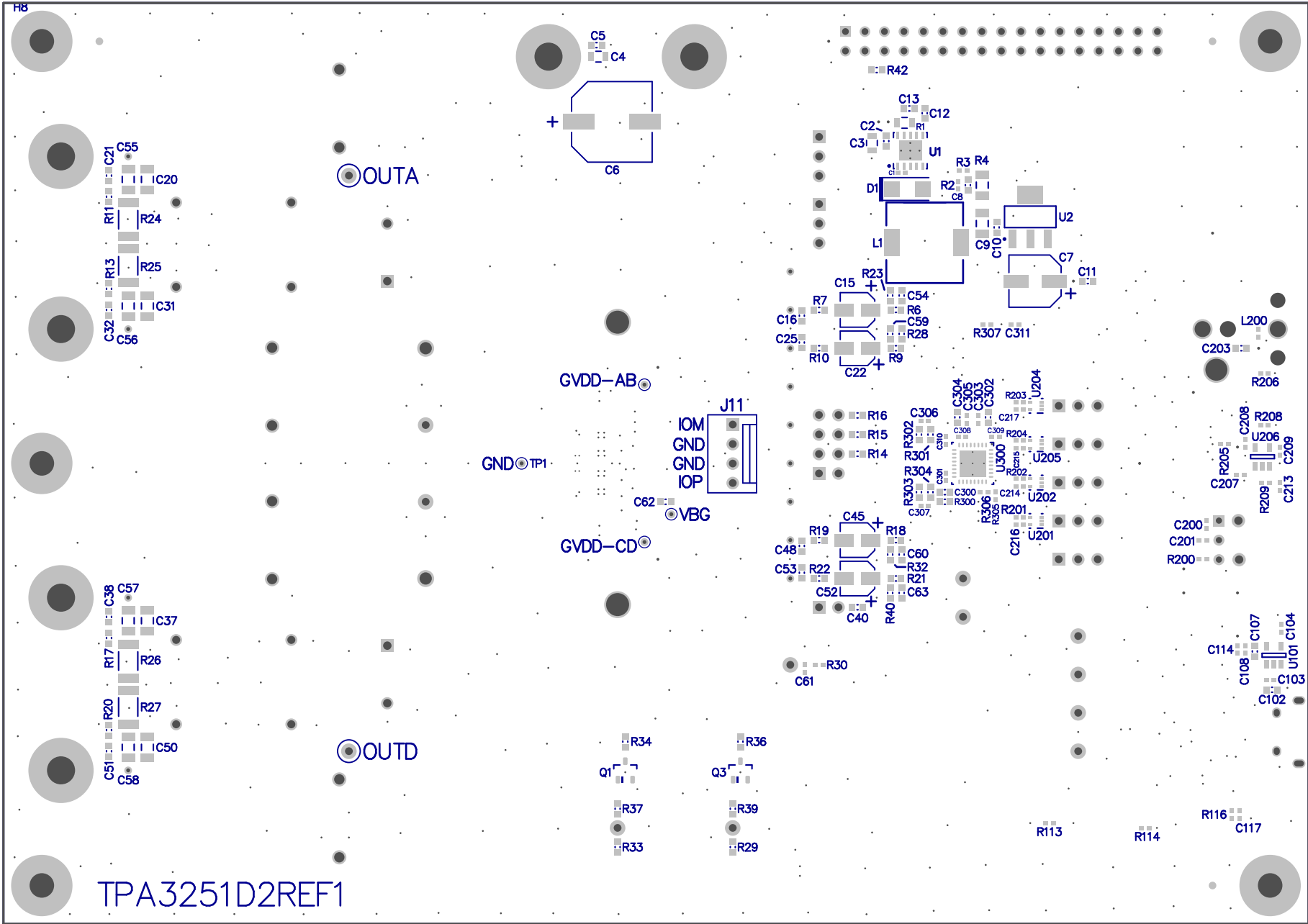
Top Copper
Top Copper



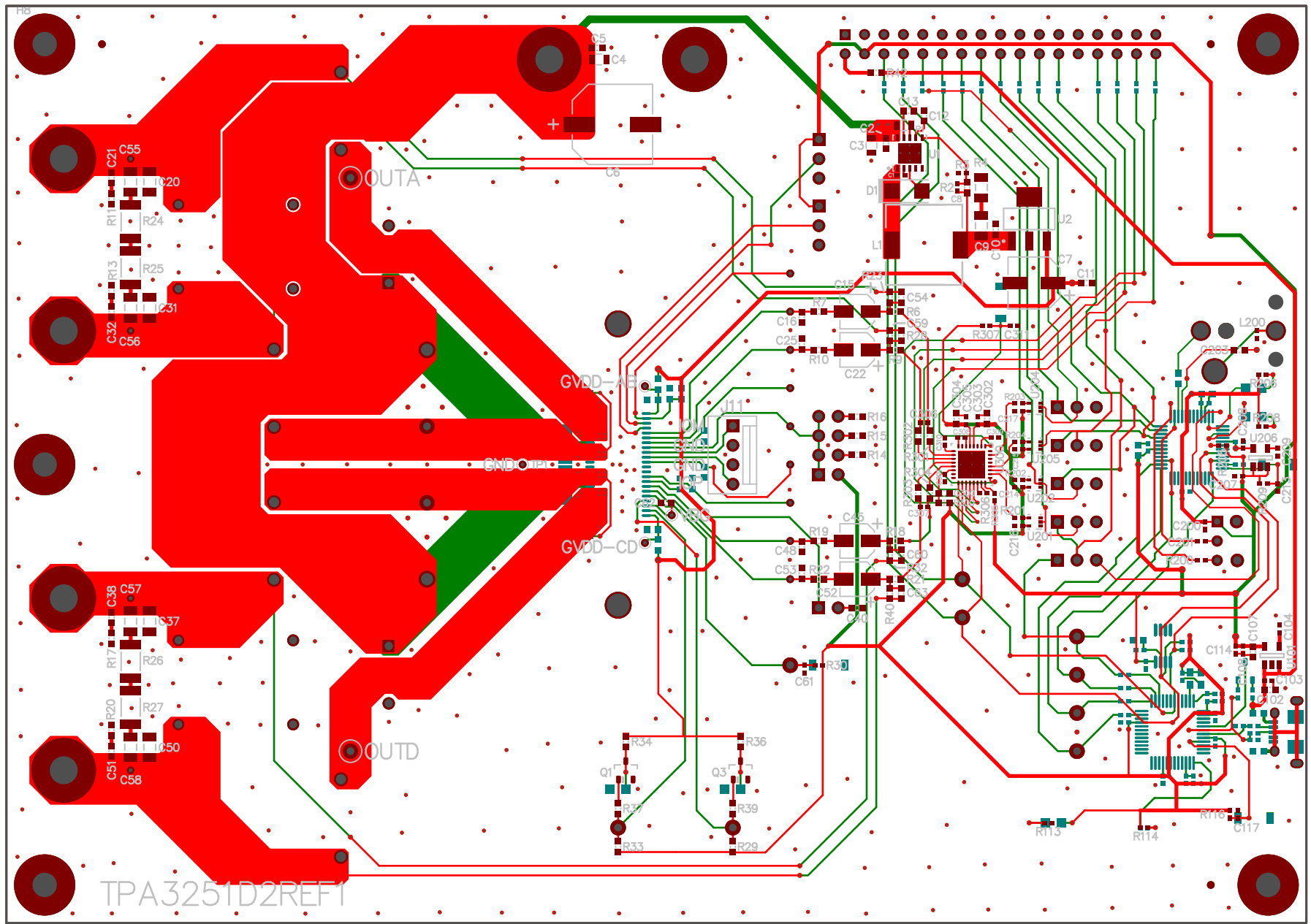
Bottom Copper
Bottom Copper

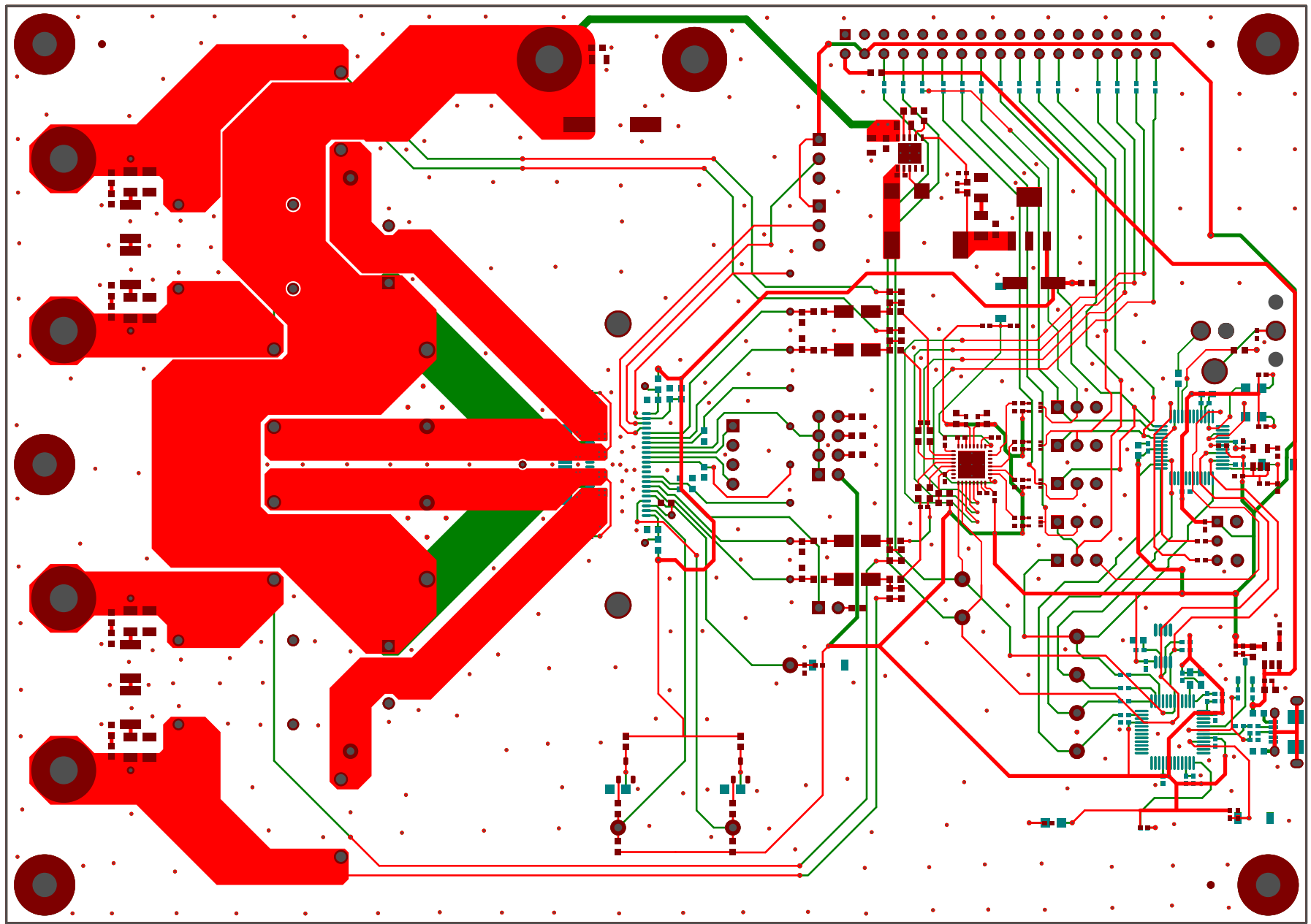


Bottom Copper
 Bottom Copper
 Bottom Silk

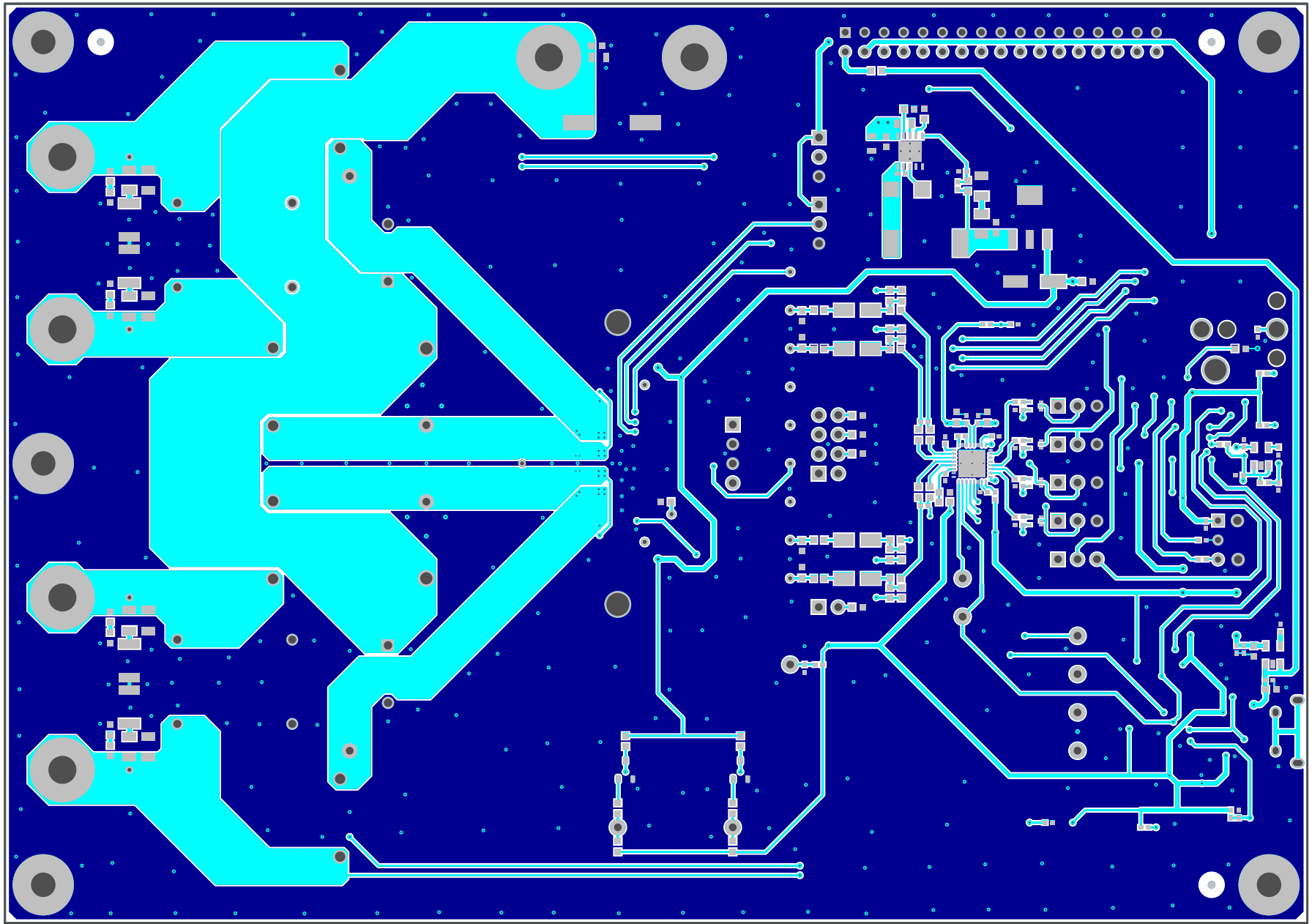


TPA3251D2REF1





Top Copper
Bottom Copper



Bottom Copper
Bottom Copper

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